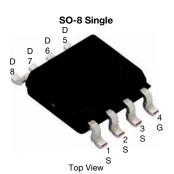


# N-Channel 60 V (D-S) MOSFET



| PRODUCT SUMMARY  |        |  |  |  |  |
|--|--------|--|--|--|--|
| V <sub>DS</sub> (V)  | 60     |  |  |  |  |
| $R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS} = 10 \text{ V}$  | 0.0042 |  |  |  |  |
| $R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS} = 6 \text{ V}$   | 0.0054 |  |  |  |  |
| $R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS} = 4.5 \text{ V}$ | 0.0069 |  |  |  |  |
| Q <sub>g</sub> typ. (nC)                                   | 18.8   |  |  |  |  |
| I <sub>D</sub> (A) <sup>a</sup>                            | 32.1   |  |  |  |  |
| Configuration  | Single |  |  |  |  |

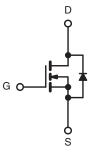
#### **FEATURES**

- TrenchFET® power MOSFET
- 100 % R<sub>g</sub> and UIS tested
- Material categorization: For definitions of compliance please see www.vishay.com/doc?99912



### **APPLICATIONS**

- DC/DC primary side switch
- Industrial
- Synchronous rectification
- · Load switch
- DC/DC converters
- DC/AC inverters



N-Channel MOSFET

| ORDERING INFORMATION            |                 |  |  |  |
|---------------------------------|-----------------|--|--|--|
| Package                         | SO-8            |  |  |  |
| Lead (Pb)-free and halogen-free | Si4062DY-T1-GE3 |  |  |  |

| <b>ABSOLUTE MAXIMUM RATINGS</b>                    | $(T_A = 25  ^{\circ}C, \text{ unless})$ | otherwise noted | d)                   |     |
|--|---|-----------------|----------------------|-----|
| PARAMETER  | SYMBOL                                  | LIMIT           | UNIT                 |     |
| Drain-source voltage                               |   | V <sub>DS</sub> | 60                   | V   |
| Gate-source voltage                                |   | V <sub>GS</sub> | ± 20                 | v   |
|  | T <sub>C</sub> = 25 °C                  |                 | 32.1                 |     |
| Continuous dusin suggest /T 150 °C)                | T <sub>C</sub> = 70 °C                  | 1 , [           | 25.7                 |     |
| Continuous drain current (T <sub>J</sub> = 150 °C) | T <sub>A</sub> = 25 °C                  | l <sub>D</sub>  | 21.5 <sup>b, c</sup> |     |
|  | T <sub>A</sub> = 70 °C                  |                 | 17 <sup>b, c</sup>   |     |
| Pulsed drain current (t = 100 μs)                  | I <sub>DM</sub>                         | 150             | A                    |     |
|  | T <sub>C</sub> = 25 °C                  |                 | 7                    |     |
| Continuous source-drain diode current              | T <sub>A</sub> = 25 °C                  | - Is            | 3.1 <sup>b, c</sup>  |     |
| Single pulse avalanche current                     | 1 04                                    | I <sub>AS</sub> | 25                   |     |
| Avalanche energy                                   | L = 0.1 mH                              | E <sub>AS</sub> | 31.2                 | mJ  |
| Maximum power dissipation                          | T <sub>C</sub> = 25 °C                  |                 | 7.8                  |     |
|  | T <sub>C</sub> = 70 °C                  | 1 5             | 5                    |     |
|  | T <sub>A</sub> = 25 °C                  | P <sub>D</sub>  | 3.5 b, c             | ─ W |
|  | T <sub>A</sub> = 70 °C                  |                 | 2.2 b, c             |     |
| Operating junction and storage temperature ra      | T <sub>J</sub> , T <sub>stg</sub>       | -55 to +150     | °C                   |     |

| THERMAL RESISTANCE RATINGS       |              |                   |         |      |      |  |
|----------------------------------|--------------|-------------------|---------|------|------|--|
| PARAMETER                        | SYMBOL       | TYPICAL           | MAXIMUM | UNIT |      |  |
| Maximum junction-to-ambient b, d | t ≤ 10 s     | $R_{thJA}$        | 29      | 35   | °C/W |  |
| Maximum junction-to-foot (drain) | Steady state | R <sub>thJF</sub> | 13      | 16   | C/VV |  |

#### Notes

- a. Based on  $T_C$  = 25 °C
- b. Surface mounted on 1" x 1" FR4 board
- d. Maximum under steady state conditions is 80 °C/W



# Vishay Siliconix

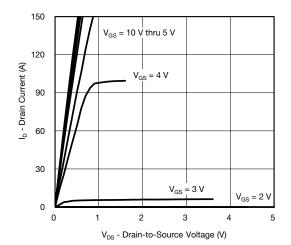
| PARAMETER  | SYMBOL                  | TEST CONDITIONS   | MIN. | TYP.   | MAX.   | UNIT  |  |
|--|-------------------------|---|------|--------|--------|-------|--|
| Static   | •                       |   | · ·  |        | •      | ı     |  |
| Drain-source breakdown voltage                       | V <sub>DS</sub>         | $V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$                         | 60   | -      | -      | V     |  |
| V <sub>DS</sub> temperature coefficient              | $\Delta V_{DS}/T_{J}$   | J 050 A   | -    | 96     | -      |       |  |
| V <sub>GS(th)</sub> temperature coefficient          | $\Delta V_{GS(th)}/T_J$ | I <sub>D</sub> = 250 μA   | -    | -5.8   | -      | mV/°C |  |
| Gate-source threshold voltage                        | V <sub>GS(th)</sub>     | $V_{DS} = V_{GS}, I_D = 250 \mu A$                                    | 1.4  | -      | 2.6    | V     |  |
| Gate-source leakage                                  | I <sub>GSS</sub>        | $V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$                     | -    | -      | ± 100  | nA    |  |
|  |                         | $V_{DS} = 60 \text{ V}, V_{GS} = 0 \text{ V}$                         | -    | -      | 1      | μА    |  |
| Zero gate voltage drain current                      | I <sub>DSS</sub>        | V <sub>DS</sub> = 60 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 55 °C | -    | -      | 10     |       |  |
| On-state drain current <sup>a</sup>                  | I <sub>D(on)</sub>      | $V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$                       | 30   | -      | -      | Α     |  |
|  |                         | V <sub>GS</sub> = 10 V, I <sub>D</sub> = 20 A                         | -    | 0.0035 | 0.0042 |       |  |
| Drain-source on-state resistance <sup>a</sup>        | R <sub>DS(on)</sub>     | $V_{GS} = 6 \text{ V}, I_D = 15 \text{ A}$                            | -    | 0.0043 | 0.0054 | Ω     |  |
|  | ` '                     | $V_{GS} = 4.5 \text{ V}, I_D = 10 \text{ A}$                          | -    | 0.0055 | 0.0069 |       |  |
| Forward transconductance <sup>a</sup>                | 9 <sub>fs</sub>         | $V_{DS} = 15 \text{ V}, I_D = 20 \text{ A}$                           | -    | 80     | -      | S     |  |
| Dynamic <sup>b</sup>                                 |                         |   |      |        |        |       |  |
| Input capacitance                                    | C <sub>iss</sub>        |   | -    | 3175   | -      | pF    |  |
| Output capacitance                                   | C <sub>oss</sub>        | $V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$      | -    | 1265   | -      |       |  |
| Reverse transfer capacitance                         | C <sub>rss</sub>        |   | -    | 95     | -      |       |  |
| Total gate charge                                    |                         | $V_{DS} = 30 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 10 \text{ A}$    | -    | 40     | 60     | nC    |  |
|  | $Q_g$                   |   | -    | 18.8   | 29     |       |  |
| Gate-source charge                                   | Q <sub>gs</sub>         | $V_{DS} = 30 \text{ V}, V_{GS} = 4.5 \text{ V}, I_D = 10 \text{ A}$   | -    | 8.9    | -      |       |  |
| Gate-drain charge                                    | Q <sub>gd</sub>         |   | -    | 3.8    | -      |       |  |
| Output charge  | Q <sub>oss</sub>        | $V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}$                         | -    | 51.5   | 80     |       |  |
| Gate resistance                                      | $R_g$                   | f = 1 MHz   | 0.5  | 2      | 3      | Ω     |  |
| Turn-on delay time                                   | t <sub>d(on)</sub>      |   | -    | 52     | 100    |       |  |
| Rise time  | t <sub>r</sub>          | $V_{DD} = 30 \text{ V}, R_1 = 3 \Omega$                               | -    | 105    | 200    |       |  |
| Turn-off delay time                                  | t <sub>d(off)</sub>     | $I_D \cong 10 \text{ Å}, V_{GEN} = 4.5 \text{ V}, R_g = 1 \Omega$     | -    | 26     | 50     |       |  |
| Fall time  | t <sub>f</sub>          |   | -    | 10     | 20     |       |  |
| Turn-on delay time                                   | t <sub>d(on)</sub>      |   | -    | 16     | 30     | ns    |  |
| Rise time  | t <sub>r</sub>          | $V_{DD} = 30 \text{ V}, R_1 = 3 \Omega$                               | -    | 6      | 12     |       |  |
| Turn-off delay time                                  | t <sub>d(off)</sub>     | $I_D \cong 10 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 1 \Omega$      | -    | 34     | 70     |       |  |
| Fall time  | t <sub>f</sub>          |   | -    | 8      | 16     |       |  |
| Drain-Source Body Diode Characteris                  | tics                    |   |      |        | •      |       |  |
| Continuous source-drain diode current                | I <sub>S</sub>          | T <sub>C</sub> = 25 °C  | -    | -      | 7.1    |       |  |
| Pulse diode forward current t <sub>p</sub> = 100 µs) | I <sub>SM</sub>         |   | -    | -      | 150    | Α     |  |
| Body diode voltage                                   | $V_{SD}$                | I <sub>S</sub> = 5 A  | -    | 0.74   | 1.1    | V     |  |
| Body diode reverse recovery time                     | t <sub>rr</sub>         |   | -    | 46     | 92     | ns    |  |
| Body diode reverse recovery charge                   | Q <sub>rr</sub>         | $I_F = 5 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s},$       | -    | 44     | 88     | nC    |  |
| Reverse recovery fall time                           | t <sub>a</sub>          | T <sub>J</sub> = 25 °C  | -    | 20     | -      |       |  |
| Reverse recovery rise time                           | t <sub>b</sub>          |   | _    | 26     | -      | ns    |  |

#### Notes

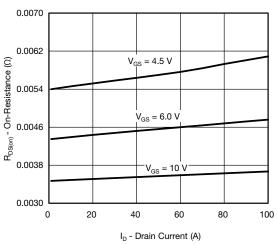
- a. Pulse test; pulse width  $\leq 300~\mu s,~duty~cycle \leq 2~\%$
- b. Guaranteed by design, not subject to production testing

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

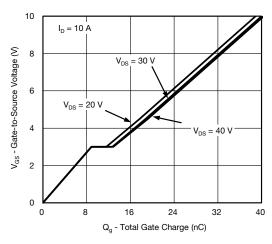




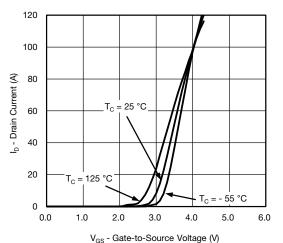
#### **Output Characteristics**



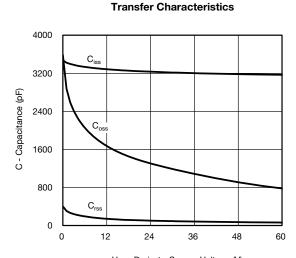
On-Resistance vs. Drain Current



**Gate Charge** 

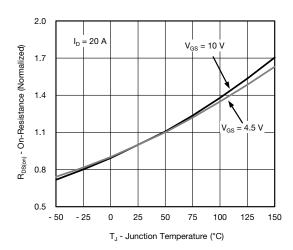


vas date to course vertage (v)



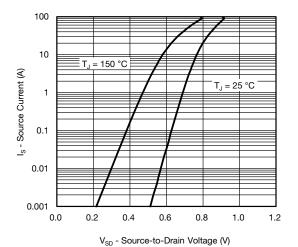
V<sub>DS</sub> - Drain-to-Source Voltage (V)



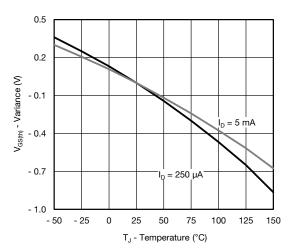


On-Resistance vs. Junction Temperature

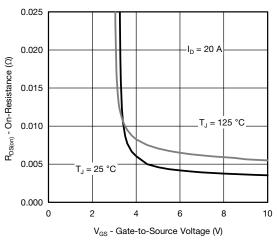




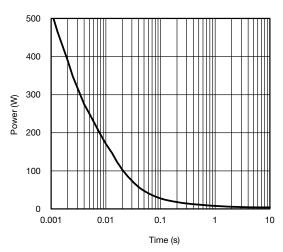
#### Source-Drain Diode Forward Voltage



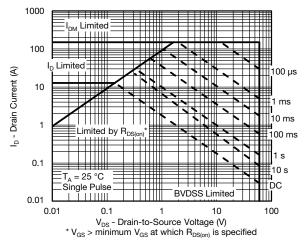
**Threshold Voltage** 



On-Resistance vs. Gate-to-Source Voltage

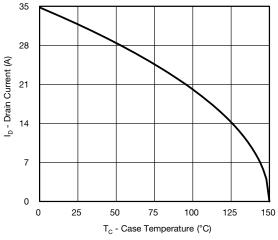


Single Pulse Power, Junction-to-Ambient

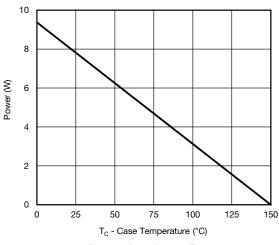


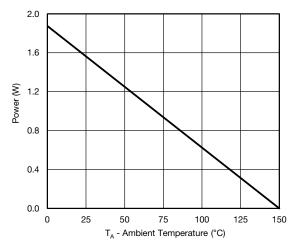
Safe Operating Area, Junction-to-Ambient





Current Derating a





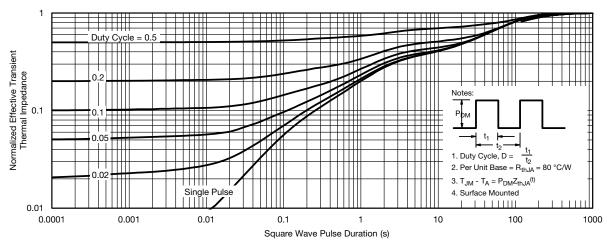
Power, Junction-to-Foot

Power, Junction-to-Ambient

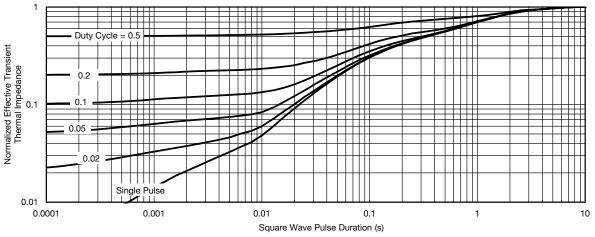
#### Note

a. The power dissipation P<sub>D</sub> is based on T<sub>J</sub> max. = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit





Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Foot

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SOIC (NARROW): 8-LEAD JEDEC Part Number: MS-012







|                                | MILLIM | IETERS | INCHES    |       |  |  |
|--------------------------------|--------|--------|-----------|-------|--|--|
| DIM                            | Min    | Max    | Min       | Max   |  |  |
| Α                              | 1.35   | 1.75   | 0.053     | 0.069 |  |  |
| A <sub>1</sub>                 | 0.10   | 0.20   | 0.004     | 0.008 |  |  |
| В                              | 0.35   | 0.51   | 0.014     | 0.020 |  |  |
| С                              | 0.19   | 0.25   | 0.0075    | 0.010 |  |  |
| D                              | 4.80   | 5.00   | 0.189     | 0.196 |  |  |
| Е                              | 3.80   | 4.00   | 0.150     | 0.157 |  |  |
| е                              | 1.27   | BSC    | 0.050 BSC |       |  |  |
| Н                              | 5.80   | 6.20   | 0.228     | 0.244 |  |  |
| h                              | 0.25   | 0.50   | 0.010     | 0.020 |  |  |
| L                              | 0.50   | 0.93   | 0.020     | 0.037 |  |  |
| q                              | 0°     | 8°     | 0°        | 8°    |  |  |
| S                              | 0.44   | 0.64   | 0.018     | 0.026 |  |  |
| ECN: C-06527-Rev. I. 11-Sep-06 |        |        |           |       |  |  |

DWG: 5498

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# LON NOTE



## **RECOMMENDED MINIMUM PADS FOR SO-8**



Recommended Minimum Pads Dimensions in Inches/(mm)

Return to Index



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